

Medium-Term Management Plan

2025-2029



1. Medium-Term Management Plan 2025–2029		
2. Sustainability	P. 17	
3. Appendix	P. 21	



1. Medium-Term Management Plan

2025-2029

Summary of the Medium-Term Management Plan (FY2025–FY2029) TOYO TANSO



Point 1 FY2029 targets — net sales: 82.0 billion yen, operating profit: 22.0 billion yen, operating profit margin:27%, ROE: 12%

- The adjustment phase in the SiC semiconductor market will cause delay in the sales plan
- Under this plan, net sales for FY2028 are just about 10% lower than under the previous plan* (excluding the impact of exchange rates) * Medium-term Management Plan (2024–2028) announced February 2024.
- An increase in sales of SiC-coated graphite products and other high-added-value products will contribute to improving profitability

Point 2 Control the balance of businesses in line with market changes and promote the establishment of new applications

• Pioneer new applications centered on semiconductor and metallurgical fields and strengthen next generation nuclear power applications (high-temperature gas furnaces) and other businesses, while controlling the balance of applications to respond to market changes

Point 3 Capital investment to total 57.0 billion yen over five years

- Continue to make capital investments in high-added-value domains in preparation for the mediumand long-term growth of the semiconductor market
- Strengthen and optimize production capacity Group-wide and maintain a top-level market share

Point 4 Optimize cash allocation

- Pay enhanced shareholder returns with a dividend minimum payout ratio of 30%
- Implement sound and steady capital investment aimed at business expansion and profit growth
- Make effective use of funds, utilizing financial leverage through borrowings, and optimize cash allocation

Targets for the Medium-Term Management Plan (2025–2029)



	FY2024	FY2025 (forecast)	FY2029 (target)	(Reference) FY2028 (previous target*1)
Net sales	53.0 billion yen	52.0 billion yen	82.0 billion yen	88.0 billion yen
Operating profit	12.2 billion yen	10.0 billion yen	22.0 billion yen	22.0 billion yen
Operating profit ratio	23.1%	19.2%	27%	25%
ROE	11.2%	7.3%	12%	12%

Exchange rate

FY2024: ¥151.6/US\$, ¥163.9/€, ¥21.0/RMB

FY2025/FY2029: ¥145/US\$, ¥154/€, ¥19.5/RMB

FY2028 (at the time of the previous plan): ¥135/US\$, ¥149/€, ¥19/RMB

► EBITDA*2 of approx. 31.5 billion yen in FY2029 (EBITDA margin of approx. 35%)

^{*1} Medium-term Management Plan (2024–2028) announced February 2024

^{*2} Operating profit +depreciation

Outlook for the Semiconductor Market



Silicon semiconductor market

- Cutting-edge products for AI will continue to sell briskly in the device market. The market is expected to see a moderate recovery in FY2025, including for other applications.
- Growth is expected to continue throughout the term of the Medium-term Management Plan due to demand for AI, 5G, data centers, automotive, and other applications.
 - Special graphite products for electronics applications: Components for Si wafer manufacturing
 - Compound SiC-coated graphite products: Parts for Si epitaxial growth equipment

SiC semiconductor market

- The SiC semiconductor market will enter an adjustment phase in FY2025 due mainly to a slowdown in BEV demand.
- Although sales are expected to be two years behind the original timeline, it is expected that a market recovery after the second half of FY2026 will enable a return to a growth trajectory, with growth expected in areas such as xEVs, automotive electrification, and the energy sector.
 - Special graphite products for electronics applications: Parts for SiC wafer manufacturing
 - Compound SiC-coated graphite products: Parts for SiC epitaxial growth equipment

Percentage of net sales from semiconductor applications in FY2029: about 50% (same level as FY2024)

Net Sales Targets by Product/Application



■ Demand for SiC semiconductor applications is expected to recover after the second half of FY2026 after an adjustment phase in FY2025. There is no significant change in the market environment for other applications, with high growth expected to continue for special graphite products for electronics applications and compound material SiC-coated graphite products.

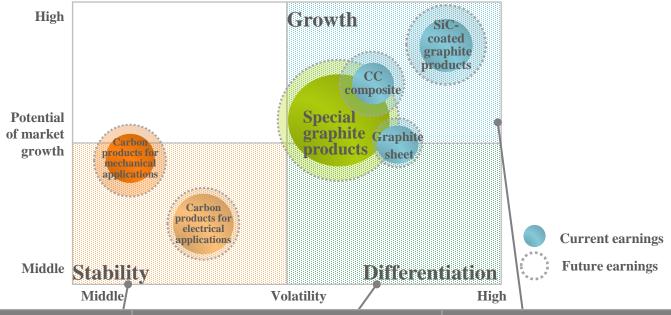
(Unit: Yen, billions)	FY2024	FY2025 (forecast)	FY2029 (target)	CAGR 2024→2029	(Reference of FY2028 (previous target*)	CAGR 2023→2028
Special graphite products	23.9	23.4	40.7	11.2%	41.9	11.8%
Carbon products for general industries (for mechanical applications)	4.0	3.8	4.8	3.6%	4.7	3.0%
Carbon products for general industries (for electrical applications)	5.0	4.9	6.1	4.2%	7.3	10.6%
Compound materials and other products	18.1	17.6	28.0	9.0%	31.2	17.3%
Related goods	1.8	2.1	2.2	4.3%	2.6	0.9%
Total	53.0	52.0	82.0	9.1%	88.0	12.3%

^{*} Medium-term Management Plan (2024–2028) announced in February 2024.

Business Portfolio



■ Control the balance of the business portfolio and respond to change through the flexible implementation of strategies suited to the business environment



Contribute to business stability, with little fluctuation in demand or profitability

Carbon products for mechanical applications

Become more cost competitive, and strengthen automotive applications and sales expansion in overseas markets

Carbon products for electrical applications Utilize strengths (delivery time, service) to pursue a higher share of growth markets (Asia, home appliances and power tools) and increase contribution

Business development focusing on high-added-value domains

- Expand market share in high-added-value domains such as semiconductors, which have high quality requirements
- Strengthen cost resilience and reduce the burden on domestic manufacturing through measures such as the utilization of contract manufacturing for more general-purpose domains

High-growth businesses driving earnings

Sales expansion leveraging the features and strengths of each product

- SiC-coated graphite products: Enhanced production capacity
- C/C composite products:
- Technical service capacity, including design

 Graphite sheet:

Customization to customer specifications

Strategies by Product/Application: Special Graphite Products





Strategy

Pursue greater competitive strength and secure profitability through stronger sales expansion in high-added-value domains

Electronics applications

- Our global top market share has been maintained for Si wafers (products for single-crystal silicon manufacturing), and we aim to further increase the share through strategies appropriate to each region.
- For SiC wafers (products for compound semiconductor applications), we will build a firm position through products with high technological added value.

■ General industry applications

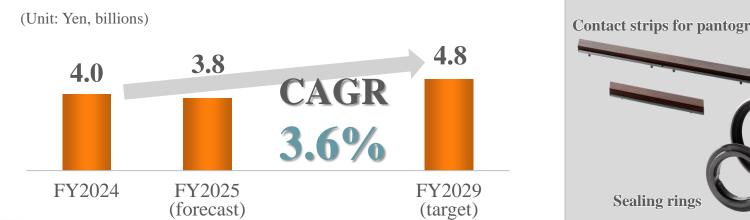
We aim to differentiate ourselves from other companies and expand profits through high-added-value sales (materials grade and processing).

Other

We will increase the contribution made by this business by expanding our market share of semiconductor applications (electrodes for ion implantation equipment, etc.) and focusing on next generation nuclear power applications (high-temperature gas furnaces).

Strategies by Product/Application: Carbon Products for General **Industries** [Carbon Products for Mechanical Applications]







Strategy

Strengthen cost competitiveness through measures such as quality improvement and automation and promote the development of new applications and customers, primarily overseas

- Aim to acquire new customers and develop new applications through stronger cost competitiveness
- · We will also raise the proportion of overseas sales from its current low level, and strengthen the processing capabilities of local subsidiaries.
- Strive for higher profitability through cost reductions and pursue appropriate resource allocation with a focus on profitability and market trends

Strategies by Product/Application: Carbon Products for General Industries [Carbon Products for Electrical Applications]





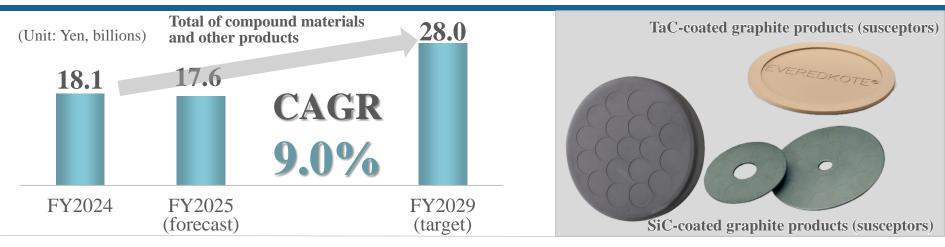
Strategy

Strengthen production technologies, including materials development and automation, to achieve high quality and low costs

- The market for home appliances and power tools bottomed out in FY2024 and has entered a moderate recovery trend. Moderate growth is expected to continue until FY2029, and we will leverage our strengths in delivery and services to expand market share through the global optimization of systems for materials development, production, etc.
- For automotive and industrial applications, we will progressively provide our unique engineering services centered on xEVs and renewable energy (wind power, hydroelectric power, etc.). At the same time, consider business expansion, including alliances, to boost the scale of sales.

Strategies by Product/Application: Compound Materials and Other Products (SiC-Coated Graphite Products)





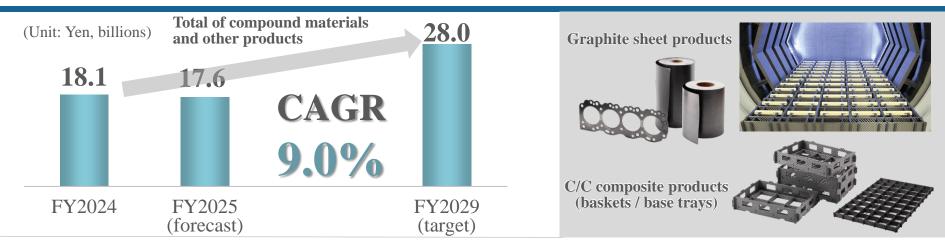
► Strategy

Double the size of net sales from core value-added businesses in the next five years through an increase in capacity

- For Si-epitaxial, we aim to maintain and expand our global top market share, responding to the technological demands of our main customers.
- For SiC-epitaxial, demand is expected to decrease in FY2025 due to an adjustment phase in the xEV market, then recover after the second half of FY2026 onward. We aim to maintain and expand our market share by capturing user demand for consumables in addition to existing sales channels.
- For LED applications, we will expand our market share, targeting large MOCVD equipment (GaN-epitaxial) for mass production in the key Chinese market.
- We will continue to strengthen our SiC/TaC coated products in preparation for a recovery in demand while maintaining a high market share through our industry-leading capabilities.
- We will promote innovations in manufacturing techniques in pursuit not only of quality but also cost saving and productivity, in anticipation of the next decade.

Strategies by Product/Application: Compound Materials and Other Products (C/C Composite Products, Graphite Sheet Products)





► Strategy

■ C/C composite products

For our focus applications (industrial furnaces and semiconductors), we will use a proposal-based approach, including development, design, and usage methods, together with stronger cost competitiveness, to capture demand for substitutes for other materials and potential demand.

- In products for industrial furnace applications, C/C composite materials have better characteristics than the metal jigs most often used at present, and replacement will be boosted by the acceleration of energy conservation, labor saving, and automation.
 - Soaring energy prices will provide a tailwind for the shift to C/C composite materials, which enable more efficient manufacturing.

■ Graphite sheet products

We will leverage our strength in customization to expand high-added-value products and new applications.

• We are engaged in improving thermally expandable graphite (raw material) at our joint venture company that produces raw materials, aiming to enhance quality and pioneer new applications.

Capital Investment



■ For isotropic graphite materials / machining / high-added-value processes and processing capacity at subsidiaries, we will build robust production systems to ensure that we capture demand for semiconductor applications.

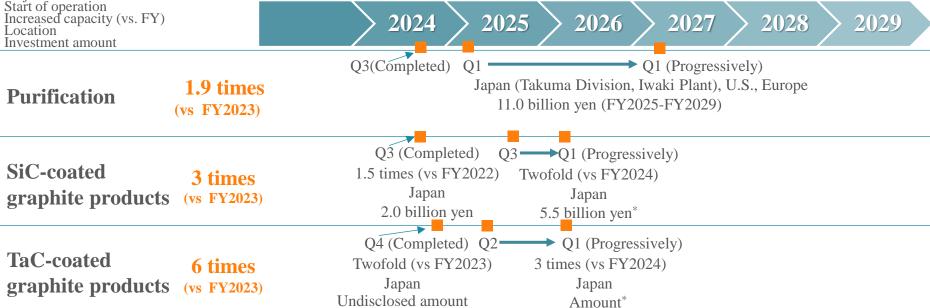
Total capital investment (FY2025-FY2029)

57.0 billion yen

Major investments Start of operation

Trajectory of capital investment based on the strategies of Medium-term Management Plan

- Boost production capacity in high-added-value businesses globally, including semiconductor applications
- Reinforce competitive strength in core/established businesses
- Labor saving, energy saving, process integration, automation, process innovation, etc.



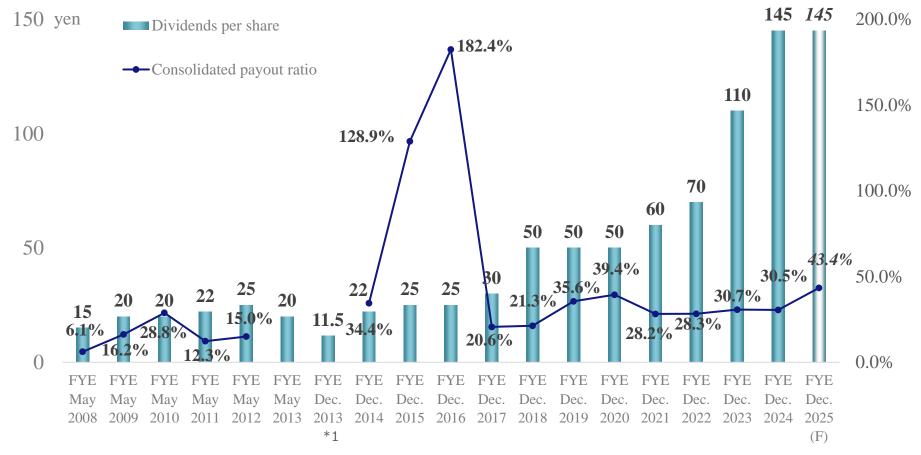
^{*}Investment amount in TaC-coated graphite product capacity to commence operation in 2025-2026 has been included in investment amount in SiC-coated graphite product capacity to commence operation in 2025–2026.

In addition, we have decided on or are considering a range of investments to boost our supply capacity and competitive strength in strategic applications, such as the development of innovative methods for manufacturing isotropic graphite materials and processing capacity enhancements in Japan and overseas.

Policy on Shareholder Returns



■ We will return profits to shareholders in a stable fashion, maintaining a dividend payout ratio of at least 30%, balanced with capital investment geared to growth against a backdrop of ongoing profit gains.



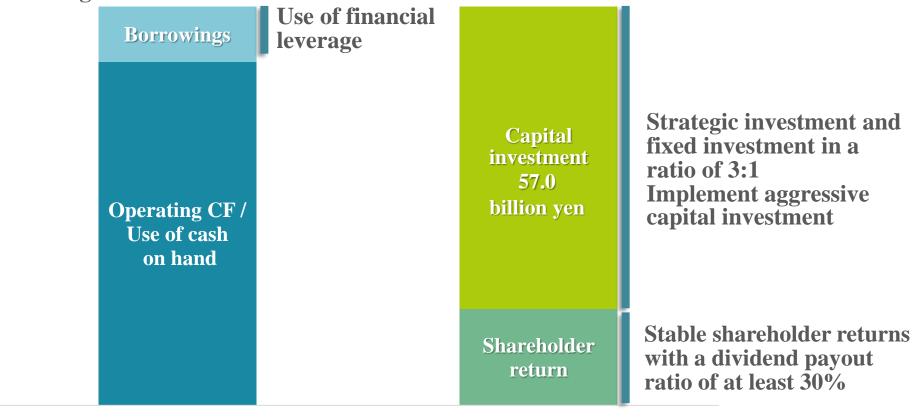
^{*1} The final day of the fiscal period was changed from May 31 to December 31 as of the fiscal year ended December 31, 2013. For this reason, the fiscal year was an irregular seven-month fiscal period (nine months for some subsidiaries).

^{*2} Since profit was negative in the fiscal year ended May 31, 2013 and the fiscal year ended December 31, 2013, information on consolidated payout ratio is excluded here.

Cash Allocation



■ We will implement shareholder return and strategic investments in business expansion through the cash generated from our high earning capacity and the use of financial leverage.



Cash inflow

Cash outflow

Achieve business expansion and profit growth and enhance capital efficiency through the effective use of cash for strategic investment, etc.



2. Sustainability

Material Issues Facing Toyo Tanso



■ Adopted double material issues (focusing on both the impact that the environment and society have on Toyo Tanso and the impact that Toyo Tanso has on the environment and society)



Contribution to reducing climate change risk and environmental protection

- Reducing greenhouse gas emissions, including through energy savings and creation
- Contributing to the reduction of greenhouse gas emissions through products
- Using Earth-friendly raw materials and avoiding procurement risk
- Complying with various countries' environmental laws and regulations and reducing environmental impacts



Pursuing product
development and
manufacturing technologies
to resolve social issues and
customer needs

- Developing products and improving manufacturing processes to help realize a recycling-based society
- Complying with increasingly sophisticated quality requirements
- Developing new products and improving services in partnership with stakeholders



Creating safe, secure
workplace
environments where all
employees
can flourish

- Improving safe, healthy workplace environments and increasing productivity
- · Ensuring all stakeholders' human rights are respected
- Offering human resources development, training, and education programs
- Respecting workforce diversity



Undertaking corporate activities that inspire trust

- Compliance
- Strengthening crisis management capabilities
- Undertaking community service activities

Reduce Greenhouse Gas Emissions, Including Through Energy Saving and Generation

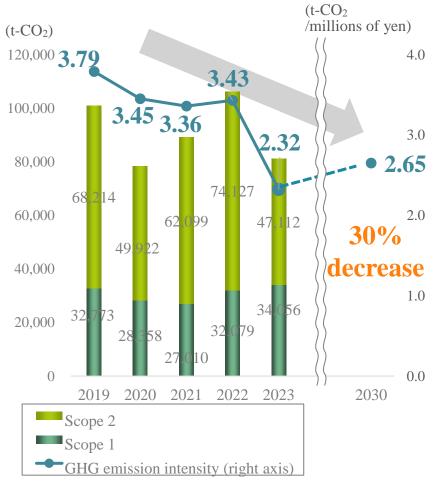


19

2030 reduction target for greenhouse gas (GHG) emission intensity (non-consolidated)

30% (vs. 2019)

■ Trend in GHG emissions (non-consolidated)



■ Progress on our GHG emissions reduction roadmap

Large = 50% or more Medium = 30% to less than 50% Small = less than 30% © = 100% or more = 90% or more = 80% to less than 90% = Less than 80%

Target Indicators	Load factor in 2030 emission reductions	FY2023 actual target achievement level	Examples of measures
(1) Introduction of energy-saving equipment	Small	0	Introduction of high-efficiency compressors Installation of LED lighting
(2) Introduction of energy with low CO ₂ emission coefficient	Large	©	Purchase of electricity from renewable energy sources (J-Credits, etc.) Purchase and introduction of electricity from renewable energy sources (solar power generation, etc.)
(3) Switching to baking furnace with smaller energy units	Small	_	Fuel conversion Furnace renewal
(4) Optimization of furnace operation time	Small	0	Promotion of energy conservation Improvement of existing facilities
(5) Optimization of furnace loading efficiency	Small	_	Improvement of yield Implementation of AI for furnace loading instructions

^{*} The "-" in the fiscal year target achievement levels will be implemented sequentially from FY2024 onwards.

Contribution to Reducing Greenhouse Gas Emissions through Products



2030 target for percentage of net sales from products that contribute to the environment (consolidated)

35%

(FY2024 result: 29.7%)

Field	Related applications and products	Proportion*
Energy saving	 Products for use with power semiconductors (silicon/SiC) Products for use with LEDs (compound semiconductor manufacturing materials) Products for use with industrial furnaces (C/C composite products) 	94% (84%)
Energy generation	 Products for use in wind power, hydroelectric, and geothermal power generation Products for use in solar power generation Products for use in the next generation of nuclear reactor Products for use in nuclear fusion reactors 	5% (15%)
Electrification	 Pump parts for use in electric vehicles Products for use in fuel cells (Catalyst-supported CNovelTM) 	1% (1%)

^{*}FY2024 results are shown on the top, with FY2023 results in parentheses underneath
For some products and applications where the final markets are diversely spread, the proportion of sales attributable to each field of environmental contribution is calculated by multiplying net sales by a proportion of sales predetermined for each application, based on various statistical data.

20



3. Appendix

Management Vision and Medium-Term Management Plan



■ Establishment of the 2030 Management Vision

The vision shows the future of the Toyo Tanso Group, the direction of challenges we will take, and the value we provide to society, to achieve further growth from the core of our founding DNA of "manufacturing completely unique products" and our pioneering spirit

"Creating products with unprecedented potential"
Becoming a leading company through Earth-friendly products and technologies





Become a global company



For the world, for society

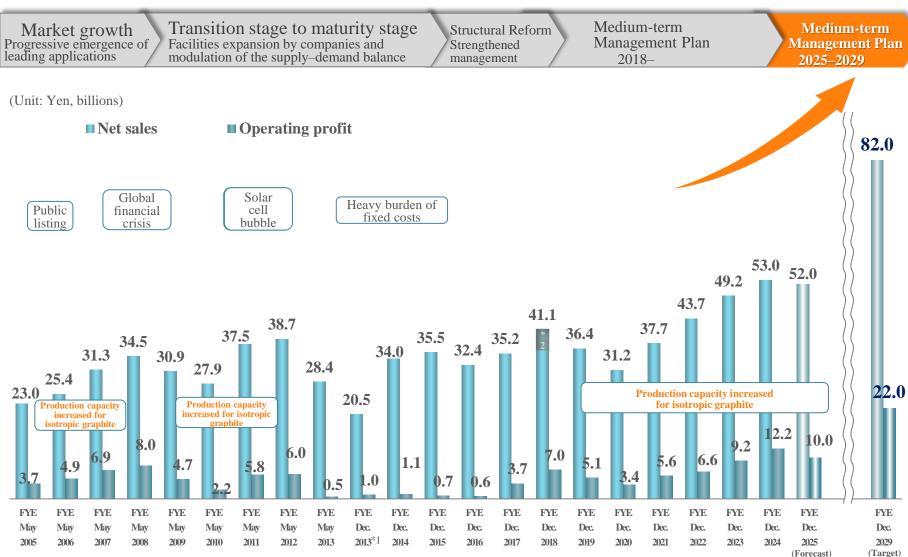


Become a strong company

Medium-term Management Plan

Trend in Net Sales and Operating Profit





^{*1} The final day of the fiscal period was changed from May 31 to December 31 as of the fiscal year ended December 31, 2013. For this reason, the fiscal year ended December 31, 2013 was an irregular seven-month fiscal period.

*2 Net sales for FY2018 include 3.2 billion yen in net sales for China's high-temperature reactor-pebble-bed modules (HTR-PM).

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Market Environment Recognition (Excluding Semiconductors)



Solar cell

Special (Electronics)

Compound (CC)

Production is restarting and expanding, even in regions outside China, with the impact of increasing momentum towards renewable energy and US-China trade frictions.

Automotive

Special (General)

General Mechanical

General (Electrical)

Compound (CC)

Compound (Sheet)

The progressive shift toward EVs has led to the expansion of electronic equipment-related markets, including an increase in the number of motors used and enhanced safety features. In addition, demand for the use of carbon in automobile parts is rising, partly due to an increasing focus on weight reduction. At the same time, some markets are being impacted by the shift away from internal combustion engines and the decrease in the number of parts used.

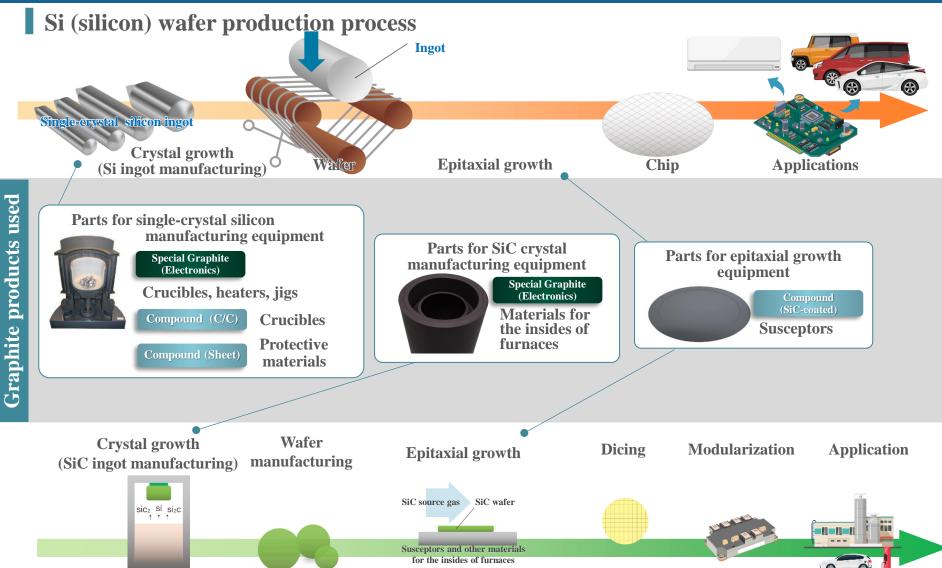
Home appliances / power tools

General (Electrical)

Demand for household washing machines and vacuum cleaners is increasing in developing countries with the rise in disposable incomes, progressive regional electrification, lifestyle changes, and increasingly advanced home appliances. Demand is also anticipated for power tools for household use and associated with capital investment in factories, and the home appliances and power tools markets are both expected to experience moderate growth.

Graphite Products Used in the Manufacturing Process of Semiconductor Devices



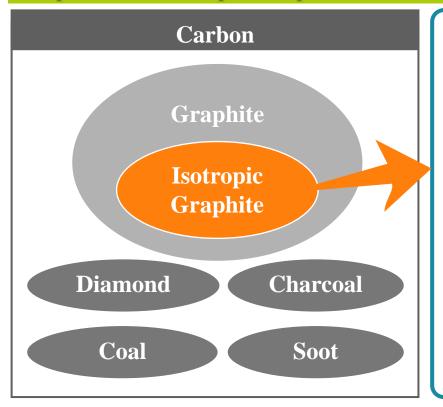


SiC wafer production process

Graphite Essential for Semiconductor Manufacturing Isotropic Graphite



Properties of Isotropic Graphite



Features of graphite

High heat resistance

Excellent thermal and electrical conductivity

Lightweight and easy to machine

Friction and wear are less likely to occur

- Properties such as thermal expansion are uniform in all directions
 - ➤ Temperature changes are unlikely to damage graphite parts
- High density and high strength with fine grain structure
 - **≻**Low consumption
- Very small variation in material properties
 - ➤ Contributing to customers' stable production and yield improvement



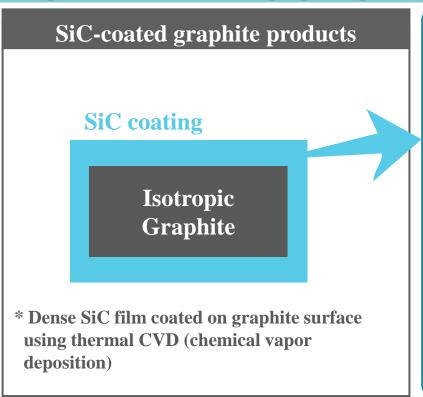
Heat treatment in a halogen gas atmosphere to remove impurities contained in graphite materials

High purity and stable quality under high temperature = Essential for semiconductor manufacturing processes

Graphite Essential for Semiconductor Manufacturing SiC-coated Graphite Products



Properties of SiC-coated graphite products





Excellent oxidation, corrosion, and chemical resistance

Extremely hard film, stable at high temperatures

High purity for graphite base materials as well High thermal conductivity and excellent heat uniformity

- Coated with a dense SiC film
 - ➤ Prevents release and dispersion of graphite powder and release of gases and impurities from the graphite base materials.
- Material design enables use at high temperatures
- ➤ Prevents cracking and peeling of the SiC film through the selection of a graphite base material with temperature variation equivalent to that of the SiC film, and maintains high dimensional accuracy even at high temperatures.



Materials that do not affect the quality of semiconductor products (Si: silicon and C: carbon)

Higher purity than isotropic graphite, stable quality under high temperature = Essential for semiconductor manufacturing processes



Toyo Tanso will help seek solutions to social challenges by developing technologies that are closely aligned with its customers.



Electronics

[Semiconductor]

Parts for crystal growth Parts for wafer processing [Electronic component] Jigs for electronic component manufacturing





Energy

[Power generation] Grounding brushes for power generators Parts for solar power generation device manufacturing Core parts for next-generation atomic reactor [Fuel cells] Catalyst carriers



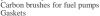




Mobility

[Trains]

Pantograph sliders [Aircraft] Engine parts manufacturing (electrodes for EDM, jigs for heat processing) [Automotive]







Social infrastructure

[Communications]

Parts for optical fiber manufacturing Parts for cable manufacturing [General industry] Packing

Sealing ring bearings







Life science

[Medical care] Target materials for CT devices Analytical column filler [Home appliances] Parts for LED manufacturing

Carbon brushes for cleaners Parts for compressors









the Sustainable Development Goals (SDGs).



TOYO T/\\\SO

Inspiration for Innovation

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In the event of any discrepancy between this translated document and the Japanese original, the original shall prevail.

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